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Specification for Approval

Customer:	ı
Model Name:	

Sı	upplier Approv	Customer approval	
R&D Designed	R&D Approved	QC Approved	
Peter	Peng Jun		

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Revision Record

REV NO.	REV DATE	CONTENTS	Note
Α	2012-07-10	NEW ISSUE	
В	2013-07-04	Change Interface 48 PIN to NC	
С	2019-05-16	Modify Backlight and FPC	
D	2024-03-12	Modify Backlight	

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1. Scope

This specification defines general provisions as well as inspection standards for TFT module supplied by AMSON electronics.

If the event of unforeseen problem or unspecified items may occur, naturally shall negotiate and agree to solution.

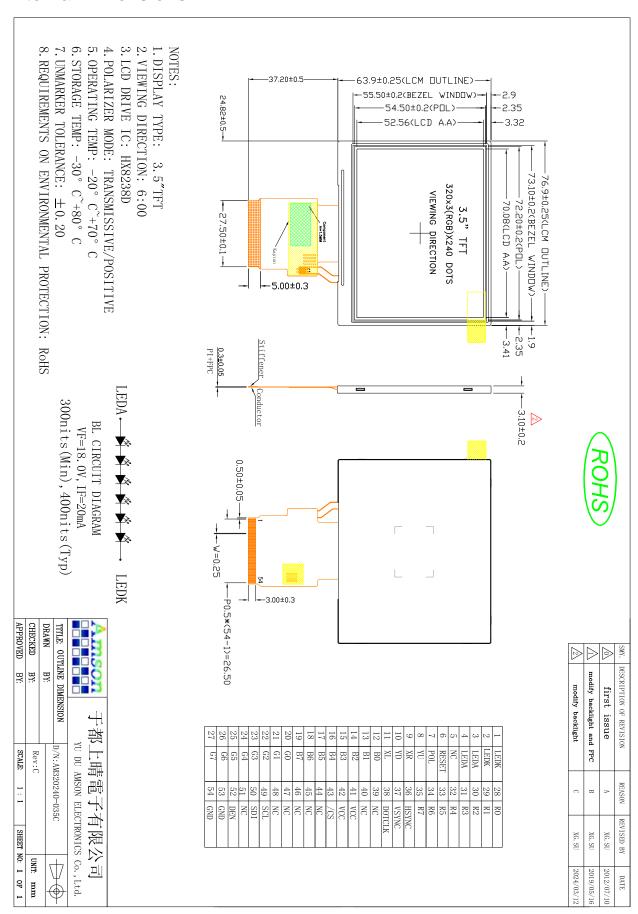
2. General Information

ITEM	STANDARD VALUES	UNITS
LCD type	3.5"TFT	
Dot arrangement	320(RGB)×240	dots
Color filter array	RGB vertical stripe	
Display mode	TN / Transmission / Normally White	
Gray Scale Inversion Direction	6 O'clock	
Eyes Viewing Direction	12 O'clock	
Driver IC	HX8238-D	
Module size	76.90(W)×63.90(H)×3.10(T)	mm
Active area	70.08(W)×52.56(H)	mm
Dot pitch	0.219(W)×0.219(H)	mm
Interface	24-bit RGB interface	
Operating temperature	-20 ~ +70	°C
Storage temperature	-30 ~ +80	°C
Back Light	6 White LED	

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3. External Dimensions





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4. Interface Description

PIN NO.	PIN NAME	DESCRIPTION
1~2	LEDK	LED backlight cathode
3~4	LEDA	LED backlight anode
5	NC	No connection
6	RESET	Reset signal input terminal, active at 'L'
7	POL	Write signal input terminal, Active at 'L'. Synchronizing clock signal in SPI mode.
8	YU	connection /TP Up
9	XR	connection /TP Right
10	YD	connection /TP Bottom.
11	XL	connection /TP Left
12~19	В0	Data bus
20~27	G0	Data bus
28~35	R0	Data bus
36	HSYNC	Line synchronizing signal for RGB interface operation.
37	VSYNC	Frame synchronizing signal for RGB interface operation.
38	DOTCLK	Dot clock signal for RGB interface operation.
39~40	NC	No connection
41~42	VCC	Power Voltage
43	/CS	Chip select signal input terminal, Active at 'L'
44~48	NC	No connection
49	SCL	Write signal input terminal, Active at 'L'. Synchronizing clock signal in SPI mode.
50	SDI	SPI interface input pin.
51	NC	No connection
52	DE	Data ENEABLE signal for RGB interface operation.
53	GND	Power ground
54	GND	Power ground



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5. Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit
Power Voltage	VCC	-0.3	4.6	V
Input Voltage	Vin	-0.3	VCC +0.3	V
Operating Temperature	Тор	-20	70	°C
Storage Temperature	Тѕт	-30	80	°C
Storage Humidity	HD	20	90	%RH

6. DC Characteristics

Item	Symbol	Min.	Тур.	Max.	Unit	Remark
Power Voltage	VDD	2.5	2.8	3.6	V	-
Input High Voltage	V _{IH}	0.7VCC	-	VCC	V	-
Input Low Voltage	V_{IL}	GND	-	0.3 VCC	V	-
Output High Voltage	V_{OH}	0.8 VCC	-	VCC	V	-
Output Low Voltage	V_{OL}	GND	-	0.2 VCC	V	-
I/O Leak Current	ILI	-1	-	1	uA	-

POL

AM-320240-035C

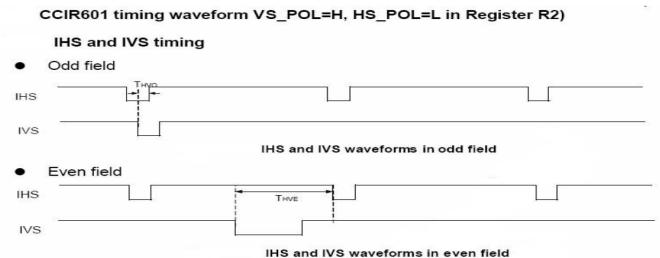
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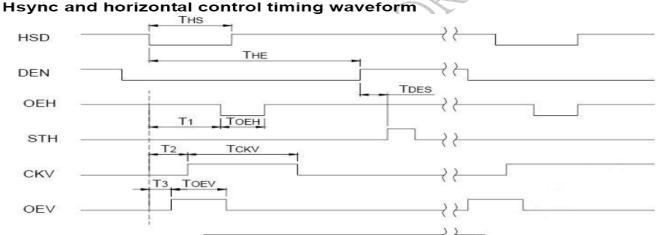
7. Timing Characteristics

7.1.1 Parallel RGB Interface Timing Characteristics

Hsync and Vsync timing



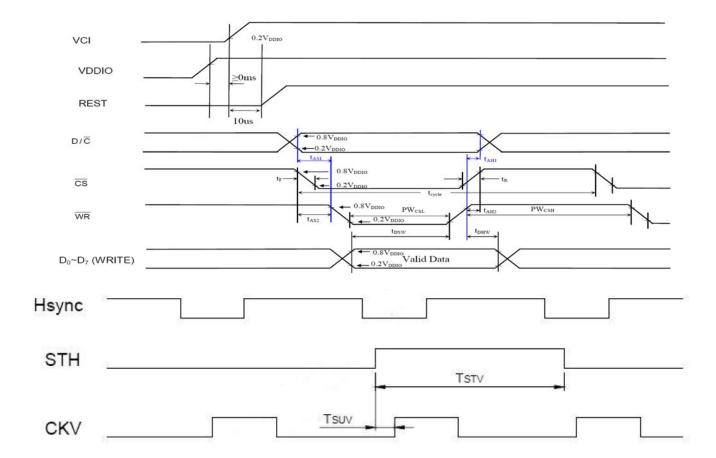
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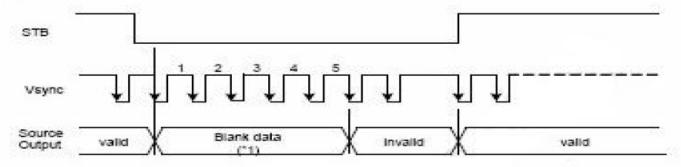
Hsync and vertical shift clock timing waveform



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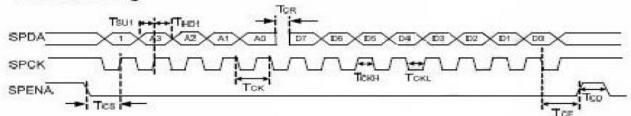
7.1.2 Power Up Sequence for RGB mode



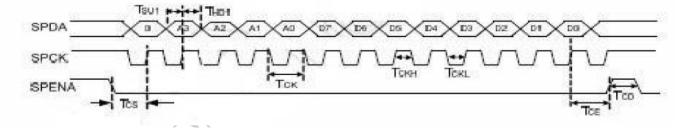
7.1.3 SPI Timing Characteristics

PARAMETER	Symbol	Min.	Тур.	Max.	Unit
SPCK period	T _{CK}	60	1746	23	ns
SPCK high width	Тскн	30	1946	20	ns
SPCK low width	TCKL	30	I sa e s	-	ns
Data setup time	T _{SU1}	12	1746	. 21	ns
Data hold time	THD1	12	1946	- E3	ns
SPENA to SPCK setup time	Tcs	20	S 15 - 5	-	ns
SPENA to SPDA hold time	TCE	20	1/2	23	ns
SPENA high pulse width	Ton	50	14		ns
SPDA output latency	T _{CR}	25.455	1/2		Tck

SPI read timing

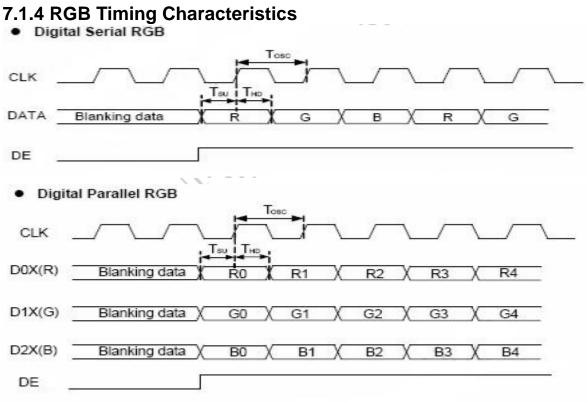


SPI write timing



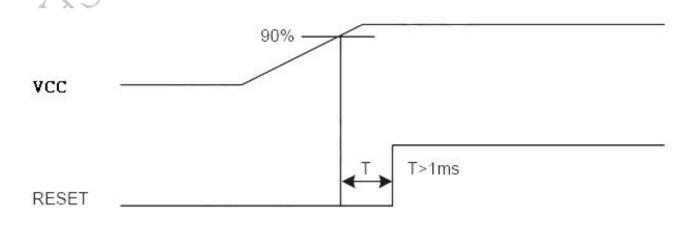
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7.2 Reset Timing Characteristics

The RESET input must be held at least 1ms after power is stable



Reset timing



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8. Backlight Characteristics

BL Circuit Diagram:



Item	Symbol	MIN	TYP	MAX	UNIT	Test Condition
Supply Voltage	Vf	16.8	18	21	V	lf=20mA
Supply Current	If	-	20	-	mA	-
Luminous Intensity for LCM	-	300	400	-	Cd/m ²	If=20mA
Uniformity for LCM	-	80	-	-	%	lf=20mA
Life Time(25°C)	-	50000	-	-	Hr	lf=20mA
Backlight Color	White					



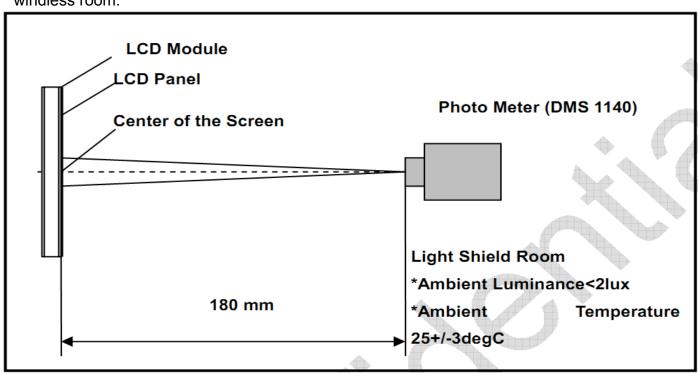
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9. Optical Characteristics

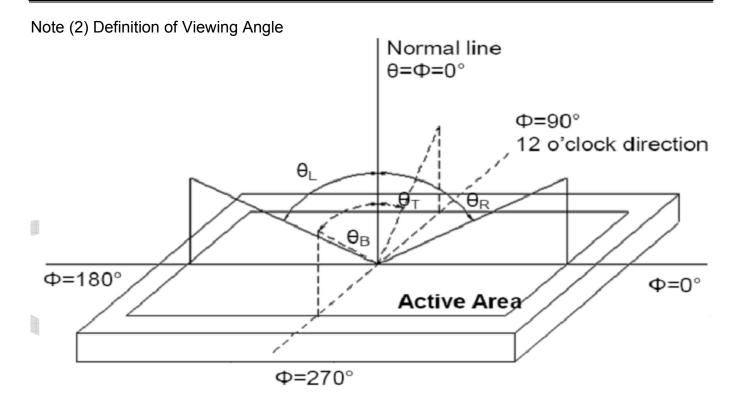
Item	Condition	s	Min.	Тур.	Max.	Unit	Note
	Horizontal	θL	-	(15)	-		
Viewing Angle	Honzontai	θR	-	(35)	-		(4) (2) (6)
(CR>10)	Vertical	θт	-	(45)	-	degree	(1),(2),(6)
	vertical	θв	-	(45)	-		
Contrast Ratio	Center		200	300	-	-	(1),(3),(6)
Response Time	Rising		-	15	30	ma	(1) (4) (6)
	Falling		-	35	50	ms	(1),(4),(6)
	Red x			TBD		-	
	Red y			TBD		-	
	Green x			TBD		-	
CF Color	Green y			TBD		-	(4) (6)
Chromaticity (CIE1931)	Blue x		Тур.	TBD	Тур.	-	(1), (6)
	Blue y		-0.05	TBD	+0.05	-	
	White x			0.2774		-	
	White y			0.2876		-	
Transmittance	-		-	5.0	-	%	(1),(5),(6)

Note (1) Measurement Setup: The LCD module should be stabilized at given temp. 25°C for 15 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting backlight for 15 minutes in a windless room.



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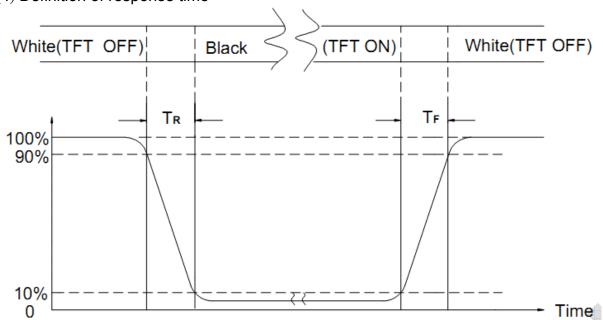


Note (3) Definition of Contrast Ratio (CR)

The contrast ratio can be calculated by the following expression Contrast Ratio (CR) = L63 / L0

L63: Luminance of gray level 63, L0: Luminance of gray level 0

Note (4) Definition of response time



Note (5) Definition of Transmittance (Module is without signal input)

Transmittance = Center Luminance of LCD / Center Luminance of Back Light x 100%

Note (6) Definition of color chromaticity (CIE1931)

Color coordinates measured at the center point of LCD



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10. Reliability Test Conditions and Methods

NO.	TEST ITEMS	TEST CONDITION	INSPECTION AFTER TEST
	High Temperature Storage	80°C±2°C×96Hours	
	Low Temperature Storage	-30°C±2°C×96Hours	
	High Temperature Operating	70°C±2°C×96Hours	
	Low Temperature Operating	-20°C±2°C×96Hours	Inspection after 2~4hours storage at room temperature, the samples
	Temperature Cycle(Storage)	-20°C \longrightarrow 25°C \longrightarrow 70°C (30min) (30min) 1cycle Total 10cycle	should be free from defects: 1, Air bubble in the LCD. 2, Seal leak. 3, Non-display. 4, Missing segments.
	Damp Proof Test (Storage)	50°C±5°C×90%RH×96Hours	5, Glass crack. 6, Current IDD is twice
	Vibration Test	Frequency:10Hz~55Hz~10Hz Amplitude:1.5MM X,Y,Z direction for total 3hours (packing condition test will be tested by a carton)	higher than initial value. 7, The surface shall be free from damage. 8, The electric characteristic requirements shall be satisfied.
	Drooping Test	Drop to the ground from 1M height one time every side of carton. (packing condition test will be tested by a carton)	orian po dationou.
	ESD Test	Voltage:±8KV,R:330Ω,C:150PF,Air Mode,10times	

REMARK:

- 1, The Test samples should be applied to only one test item.
- 2. Sample side for each test item is 5~10pcs.
- 3,For Damp Proof Test, Pure water(Resistance $> 10M\Omega$)should be used.
- 4,In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judge as a good part.
- 5, EL evaluation should be accepted from reliability test with humidity and temperature: Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and Fluorescence EL has.
- 6, Failure Judgment Criterion: Basic Specification Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.



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11. Inspection Standard

11.1. QUALITY:

THE QUALITY OF GOODS SUPPLIED TO PURCHASER SHALL COME UP TO THE FOLLOWING STANDARD.

11.1.1. THE METHOD OF PRESERVING GOODS

AFTER DELIVERY OF GOODS FROM AMSON TO PURCHASER. PURCHASER SHALL CONTROL THE LCM AT -10 $^{\circ}$ C TO 40 $^{\circ}$ C, AND IT MIGHT BE DESIRABLE TO KEEP AT THE NORMAL ROOM TEMPERATURE AND HUMIDITY UNTIL INCOMING INSPECTION OR THROWING INTO PROCESS LINE.

11.1.2. INCOMING INSPECTION

(A) THE METHOD OF INSPECTION

IF PURCHASER MAKE AN INCOMING INSPECTION, A SAMPLING PLAN SHALL BE APPLIED ON THE CONDITION THAT QUALITY OF ONE DELIVERY SHALL BE REGARDED AS ONE LOT.

(B) THE STANDARD OF QUALITY

ISO-2859-1 (SAME AS MIL-STD-105E), LEVEL II SINGLE PLAN.

CLASS	AQL(%)
CRITICAL	0.4 %
MAJOR	0.65 %
MINOR	1.5 %
TOTAL	1.5 %

EVERY ITEM SHALL BE INSPECTED ACCORDING TO THE CLASS.

(C) MEASURE

IF AS THE RESULT OF ABOVE RECEIVING INSPECTION, A LOT OUT IS DISCOVERED. PURCHASER SHALL BE INFORM SELLER OF IT WITHIN SEVEN DAYS. BUT FIRST SHIPMENT WITHIN FOURTEEN DAYS.

11.1.3. WARRANTY POLICY

AMSON WILL PROVIDE ONE-YEAR WARRANTY FOR THE PRODUCTS ONLY IF UNDER SPECIFICATION OPERATING CONDITIONS. AMSON WILL REPLACE NEW PRODUCTS FOR THESE DEFECT PRODUCTS WHICH UNDER WARRANTY PERIOD AND BELONG TO THE RESPONSIBILITY OF AMSON.

11.2. CHECKING CONDITION

- 11.2.1. CHECKING DIRECTION SHALL BE IN THE 45 DEGREE AREA TO FACE THE SAMPLE.
- 11.2.2. CHECKER SHALL SEE OVER 300±25 mm. WITH BARE EYES FAR FROM SAMPLE AND USING 2 PCS. OF 20W FLUORESCENT LAMP.



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11.3. INSPECTION PLAN:

11.0.11101 20	TION FLAN.		
CLASS	ITEM	JUDGEMENT	CLASS
PACKING &	OUTSIDE AND INSIDE PACKAGE	"MODEL NO." , "LOT NO." AND "QUANTITY" SHOULD INDICATE ON THE PACKAGE.	Minor
INDICATE	2. MODEL MIXED AND QUANTITY	OTHER MODEL MIXEDREJECTED QUANTITY SHORT OR OVERREJECTED	Critical
	3. PRODUCT INDICATION	"MODEL NO." SHOULD INDICATE ON THE PRODUCT	Major
ASSEMBLY	4. DIMENSION, LCD GLASS SCRATCH AND SCRIBE DEFECT.	ACCORDING TO SPECIFICATION OR DRAWING.	Major
APPEARANCE	5. VIEWING AREA	POLARIZER EDGE OR LCD'S SEALING LINE IS VISABLE IN THE VIEWING AREAREJECTED	Minor
	6. BLEMISH - BLACK SPOT - WHITE SPOT IN THE LCD AND LCD GLASS CRACKS	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
	7. BLEMISH · BLACK SPOT WHITE SPOT AND SCRATCH ON THE POLARIZER	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
	8. BUBBLE IN POLARIZER	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
	9. LCD'S RAINBOW COLOR	STRONG DEVIATION COLOR (OR NEWTON RING) OF LCDREJECTED. OR ACCORDING TO LIMITED SAMPLE (IF NEEDED, AND INSIDE VIEWING AREA)	Minor
	10. ELECTRICAL AND OPTICAL CHARACTERISTICS (CONTRAST, VOP, CHROMATICITY ETC)	ACCORDING TO SPECIFICATION OR DRAWING . (INSIDE VIEWING AREA)	Critical
ELECTRICAL	11.MISSING LINE	MISSING DOT: LINE : CHARACTERREJECTED	Critical
	12.SHORT CIRCUIT- WRONG PATTERN DISPLAY	NO DISPLAY - WRONG PATTERN DISPLAY - CURRENT CONSUMPTION OUT OF SPECIFICATION REJECTED	Critical
	13. DOT DEFECT (FOR COLOR AND TFT)	ACCORDING TO STANDARD OF VISUAL INSPECTION	Minor



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11.4 STANDARD OF VISUAL INSPECTION

THE CELL BLEMISH LENGTH WIDTH ACCEPTAGE SCRATCH	I		
	I		
BLACK AND WHITE SPOT FOREIGN MINOR MINOR MINOR $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$			
BLACK AND WHITE SPOT FOREIGN MATERIEL DUST IN THE CELL BLEMISH SCRATCH BLACK AND WHITE SPOT FOREIGN NOTE: Ø=(LENGTH*WIDTH)/2 (S) LINE TYPE: LENGTH WIDTH ACCEPTABE	ōmm)		
SPOT FOREIGN MINOR MINOR MATERIEL DUST IN THE CELL BLEMISH SCRATCH SCRATCH NOTE: Ø=(LENGTH*WIDTH)/2 (S) LINE TYPE: ur LENGTH WIDTH ACCEPTAE			
SPOT FOREIGN MINOR SPOT FOREIGN MATERIEL DUST IN THE CELL BLEMISH SCRATCH NOTE: Ø=(LENGTH*WIDTH)/2 (S) LINE TYPE: ur LENGTH WIDTH ACCEPTAE			
THE CELL BLEMISH LENGTH WIDTH ACCEPTAGE SCRATCH	NOTE: Ø=(LENGTH*WIDTH)/2		
SCRATCH SCRATCH WIDTH ACCEPTAGE	nit: mm		
SURATUR WILLIAM	BLE QTY		
W≤ 0.03 Disreg	gard		
L ≤5.0 0.03 < W ≤ 0.07 3 (Distance	d ≥ 5mm		
0.07 < W FOLLOW RO	UND TYPE		
NOTE: Ø=(LENGTH*WIDTH)/2			
l l	ınit: mm.		
DIAMETER ACCEPTABLE	Q'TY		
BUBBLE IN Ø<0.15 Disregard	d		
11.4.2 MINOR DENT ON 0.2<∅≤ 0.3 2(Distance≥ 5	imm)		
POLARIZER 0.3<∅ 0	,		
Items ACC. Q'T'	Υ		
Bright dot N ≤1(Distance	e ≥ 5mm)		
Dark dot N ≤2(Distance	e ≥ 5mm)		
Pixel Define :	<u> </u>		
11.4.3 MINOR Dot Defect Note Dot H Dot H Dot H Dot H 1 The deficition of a defeation of	RGE		
	whole dot is regarded as one defective dot. Definition:<1/2		
dot and visible by 5% ND filter			
2: Bright dot: Dots appear bright and unchanged	2: Bright dot: Dots appear bright and unchanged in size m which		
LCD panel is displaying under black pattern. 3: Dark dot: Dots appear dark and unchanged in	3: Dark dot: Dots appear dark and unchanged in size in which		
	LCD panel is displaying under pure red. green 、blue pattern.		
	, , , , , , , , , , , , , , , , , , ,		
11.4.3.1 MINOR Mura Not visible through 5% ND filter in 50% gray or just sample if necessary	uage by limit		
Sample if fiecessary			



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NO.	CLASS	ITEM	JUDGEMENT	
11.4.4	MINOR	LCD GLASS CHIPPING	S	Y > S Reject
11.4.5	MINOR	LCD GLASS CHIPPING	SY	X or Y > S Reject
11.4.6	MAJOR	LCD GLASS GLASS CRACK	Y	Y > (1/2) T Reject
11.4.7	MAJOR	LCD GLASS SCRIBE DEFECT	A + B	1. a> L/3 , A>1.5mm. Reject 2. B: ACCORDING TO DIMENSION
11.4.8	MINOR	LCD GLASS CHIPPING (ON THE TERMINAL AREA)	T	Φ = (x+y)/2 > 2.5 mm Reject
11.4.9	MINOR	LCD GLASS CHIPPING (ON THE TERMINAL SURFACE)	TZX	Y > (1/3) T Reject
11.4.10	MINOR	LCD GLASS CHIPPING	T Z	Y > T Reject



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12. Handling Precautions

12.1 Mounting method

The LCD panel of AMSON TFT module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

12.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent

[Recommended below] and wipe lightly

- Isopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water
- Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns Do not use the following solvent on the pad or prevent it from being contaminated:

- Soldering flux
- Chlorine (CI) , Sulfur (S)

If goods were sent without being sili8con coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Sulfur (S) from customer, Responsibility is on customer.

12.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you:

Connect any unused input terminal to VDDIO or GND, do not input any signals before power is turned on, and ground your body, work/assembly areas, and assembly equipment to protect against static electricity.

12.4 packing

- Module employs LCD elements and must be treated as such.
- Avoid intense shock and falls from a height.
- To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity

12.5 Caution for operation

- It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.
- An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.
- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- Slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.
 - Usage under the maximum operating temperature, 50%Rh or less is required.



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12.6 storing

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

- Storage in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it. And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- Storing with no touch on polarizer surface by the anything else.
 [It is recommended to store them as they have been contained in the inner container at the time of delivery from us.

12.7 Safety

- It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water.

13. Precaution for Use

13.1

A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

13.2

On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

- When a question is arisen in this specification.
- When a new problem is arisen this is not specified in this specification.
- When an inspection specifications change or operating condition change in customer is reported to AMSON TFT and some problem is arisen in this specification due to the change.
- When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

14. Packing Method

TBD